

- Industry's lowest DCR & ultra low AC losses
- AEC-Q200 Grade 1 (-40°C to +125°C)
- Superior current handling with soft saturation characteristics
- Wide inductance range from $0.055 10 \,\mu H$

Core material Composite

Core and winding loss See www.coilcraft.com/coreloss

Environmental RoHS compliant, halogen free

Terminations RoHS compliant tin-silver (96.5/3.5) over copper. Other terminations available at additional cost.

Weight: 0.46 - 0.51 gOperating voltage: 0 - 80 V

Ambient temperature -40°C to +125°C with (40°C rise) Irms current. Maximum part temperature +165°C (ambient + temp rise). Derating.

Storage temperature Component: -55°C to +165°C.

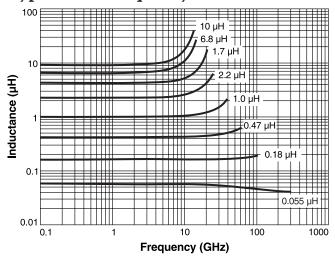
Tape and reel packaging: -55°C to +80°C

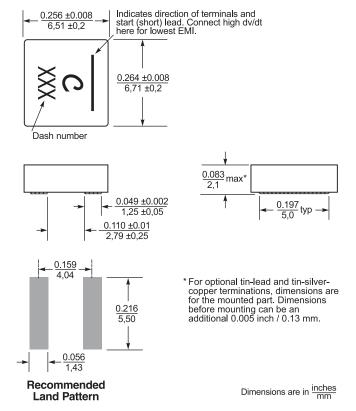
Resistance to soldering heat Max three 40 second reflows at +260°C, parts cooled to room temperature between cycles

Moisture Sensitivity Level (MSL) 1 (unlimited floor life at <30°C / 85% relative humidity)

Packaging 500/7" reel; 2500/13" reel Plastic tape: 16 mm wide, 0.35 mm thick, 12 mm pocket spacing, 2.23 mm pocket depth PCB washing Tested to MIL-STD-202 Method 215 plus an additional aqueous wash. See Doc787_PCB_Washing.pdf.

Typical L vs Frequency







US +1-847-639-6400 sales@coilcraft.com
UK +44-1236-730595 sales@coilcraft-europe.com
Taiwan +886-2-2264 3646 sales@coilcraft.com.tw
China +86-21-6218 8074 sales@coilcraft.com.cn
Singapore + 65-6484 8412 sales@coilcraft.com.sg

Document 1651-1 Revised 12/16/22

© Coilcraft Inc. 2023

This product may not be used in medical or high risk applications without prior Coilcraft approval. Specification subject to change without notice. Please check web site for latest information.







	Inductance ²	DCR (mOhms)3		SRF typ ⁴	Isat (A)₅			Irms (A) ⁶	
Part number ¹	±20% (µH)	typ	max	(MHz)	10% drop	20% drop	30% drop	20°C rise	40°C rise
XGL6020-550ME_	0.055	0.75	0.87	485	23.0	37.0	51.5	28.0	38.0
XGL6020-181ME_	0.18	1.5	1.8	150	13.8	24.0	33.0	22.4	30.4
XGL6020-331ME_	0.33	2.6	3.1	85	9.6	16.9	25.0	17.8	23.7
XGL6020-471ME_	0.47	3.5	4.2	75	8.2	13.6	19.3	15.8	21.8
XGL6020-681ME_	0.68	4.6	5.5	58	6.8	11.6	16.7	13.7	19.0
XGL6020-102ME_	1.00	6.7	8.0	45	5.5	9.2	13.4	11.0	13.9
XGL6020-152ME_	1.50	9.2	11.0	38	4.8	7.9	11.4	9.1	12.0
XGL6020-222ME_	2.20	14.0	16.1	27	3.9	6.3	8.8	8.4	11.4
XGL6020-332ME_	3.30	21.1	24.3	23	3.2	5.3	7.6	6.4	8.8
XGL6020-472ME_	4.70	29.4	33.8	18	2.5	4.2	6.0	5.6	7.7
XGL6020-562ME_	5.6	35.1	40.4	17	2.4	4.0	5.7	4.6	6.3
XGL6020-682ME_	6.8	43.3	49.8	15	2.2	3.6	5.1	4.5	6.2
XGL6020-822ME_	8.2	49.0	56.4	14.5	2.0	3.3	4.8	4.1	5.6
XGL6020-103ME_	10	67.4	77.5	14	1.8	3.1	4.4	3.5	4.7

1. When ordering, please specify **termination** and **packaging** codes:

XGL6020-103MEC

Termination: E = RoHS compliant tin-silver over copper.

Special order: T = RoHS tin-silver-copper (95.5/4/0.5) or **S** = non-RoHS tin-lead (63/37).

Packaging: C = 7" machine-ready reel. EIA-481 embossed plastic tape (500 parts per reel). Quantities less than full reel available: in tape (not machine ready) or with

leader and trailer (\$25 charge).

D = 13" machine-ready reel. EIA-481 embossed plastic tape (2500 parts per reel). Factory order only, not

stocked.

- 2. Inductance tested at 1 MHz, 0.1 Vrms, 0 Adc.
- 3. DCR measured on a micro-ohmmeter.
- 4. SRF measured using Agilent/HP 4395A or equivalent.
- DC current at 25°C that causes the specified inductance drop from its value without current.
 Click for temperature derating information.
- Current that causes the specified temperature rise from 25°C ambient.
 This information is for reference only and does not represent absolute maximum ratings. Click for temperature derating information.
- 7. Electrical specifications at 25°C.

Refer to Doc 362 "Soldering Surface Mount Components" before soldering.

Irms Testing

Irms testing was performed on 0.75 inch wide \times 0.25 inch thick copper traces in still air.

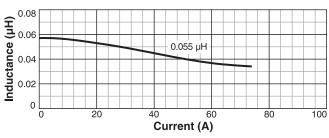
Temperature rise is highly dependent on many factors including pcb land pattern, trace size, and proximity to other components. Therefore temperature rise should be verified in application conditions.

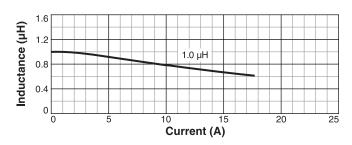


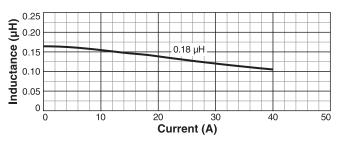


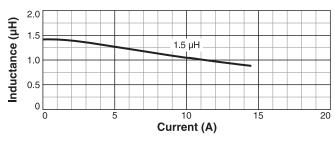
L vs Current

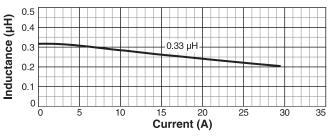


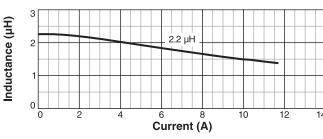


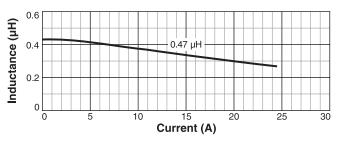


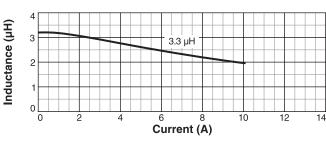


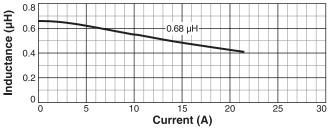


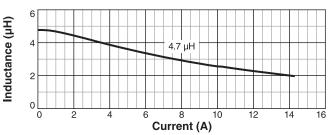
















L vs Current



